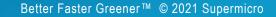


# X12/H12 GPU Systems Roadmap

SUPERMICR

Alok k Srivastav, Sr Solutions Manager November 2021







- What's New
- Why is AI booming now
- Industry trends of AI/ML & HPC
- GPU/Coprocessors/Accelerator Status/Types
- Supermicro Next Generation X12 and H12 based GPU Servers

# X12 GPU System Roadmap



Highest Performance and Flexibility for AL/ML and HPC Applications

# 4U GPU Systems

# 1U/2U GPU Systems



X12: 4U-8GPU SYS-420GP-TNAR/+

Integrated Performance, Delta GPU



X12: 2U-4GPU SYS - 220GQ-TNAR+

Scale-able Performance, Redstone GPU



X12: 4U-10GPU SYS-420GP-TNR

Dual Root Configuration, PCIe GPU



X12: 2U-6GPU SYS-220GP-TNR

Balanced Solution, PCIe GPU



X12: 4U-4GPU SYS-740GP-TNRT

Flexible Solution, PCIe GPU



X12: 1U-4GPU SYS-120GQ-TNRT

Highest Density, PCIe GPU

### X12: 2U- 2Node 3GPU \* sys-210GP-DNR

Flexible Architecture, PCIe GPU

#### \* Subject to change

## HGX A100 8-GPU (Delta) Server: SYS-420GP-TNAR/+



4U NVIDIA SXM A100 + 8-GPU Intel® Xeon® Scalable CPU System



System Front



System Rear

### Key Features

- Supports 8 A100 40GB/80GB SXM4 GPUs
- Platform with NVIDIA<sup>®</sup> NVLINK<sup>™</sup> + NVIDIA<sup>®</sup> NVSwitch<sup>™</sup>
- Dual 3rd Gen Intel® Xeon® Scalable Processors

### **Key Applications**

- AI Compute/Model Training/Deep Learning
- High-performance Computing (HPC)





	Specifications
<b>CPU –</b> Dual Socket	Memory – 32 DIMM Slots
Dual 3rd Gen Intel® Xeon® Scalable Processors	32 DIMMs, up to 8TB Registered ECC DDR4
Upto 270W TDP	3200MHz SDRAM
Drives – 6 Hot-Swap Bays 6 NVMe U.2 (4 from PCIe Switch & 2 from CPU) 2 NVMe M.2 (Internal) (Option for up to 10 hot-swap U.2 NVMe 2.5" available)	<b>Expansion –</b> 10 PCI-E Slots 8 PCIe 4.0 x16 LP from PCIe switch 2 PCIe 4.0 x16 LP from CPUs AIOM support
I/O ports	<b>Power Supply –</b> N+N Redundant
1 BMC LAN port	4x 3000W High-efficiency (Titanium level) power
1 VGA port	supply OR 4x 2200W High-efficiency (Titanium level)
2 USB 3.0 ports	power supply (3+1)

Subject to change without notice

11/11/2021

### NVIDIA HGX A100 4GPU (Redstone) Server: SYS-220GQ-TNAR+



2U NVIDIA HGX A100 4GPU Intel® Xeon® Scalable CPU System



### System Front



System Rear

### Key Features

- Supports NVIDIA<sup>®</sup> HGX A100 40GB/80GB 4GPU
- Direct connect PCI-E Gen 4 Platform with NVIDIA<sup>®</sup> NVLink™
- Dual 3<sup>rd</sup> Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Processors

### Key Applications

- Al Compute/Model Training/Deep Learning
- High-performance Computing (HPC)





	Specifications
<b>CPU –</b> Dual Socket Dual 3 <sup>rd</sup> Gen Intel® Xeon® Scalable Processors Up to 270W TDP	Memory – 32 DIMM Slots 32 DIMMs, up to 8TB Registered ECC DDR4 3200MHz SDRAM
<b>Drives –</b> 4 Hot-Swap Bays 4x 2.5" SATA 2x M.2 NVMe/SATA	<b>Expansion –</b> 4 PCI-E Slots 4x PCI-E Gen 4 x16 LP
<b>Networking –</b> Dual 10GbE 2x RJ45 10GbE 1x RJ45 1GbE IPMI	<b>Power Supply –</b> N+N Redundant 2x 3000W Titanium Level

# Data Center PCIe GPU Systems



	A100	A30	A40 / RTX A6000	A10	Т4
Design	Highest Performance Compute AI, HPC, Data Analytics	Mainstream Compute Al Inference	Highest Performance Graphics Visual Computing Rendering CloudXR	Mainstream Graphics Online Services 4K Cloud Gaming Video with Al	Inference Edge, Lower Entry Cost
Form Factor	x16 PCle Gen4 2 Slot FHFL 3 NVLink bridges	x16 PCle Gen4 2 Slot FHFL 1 NVLink bridges	x16 PCIe Gen4 2 Slot FHFL 1 NVLink bridges	x16 PCle Gen4 1 Slot FHFL	x16 PCle Gen3 1 Slot LP
Memory	40 GB HBM2	24 GB HBM2	48 GB GDDR6	24 GB GDDR6	16 GB GDDR6
MIG	Up to 7	Up to 4	N/A	N/A	N/A
Media Acceleration	1 JPEG Decoder 5 Video Decoder	1 JPEG Decoder 4 Video Decoder	1 Video Encoder 2 Video Decoder (+AV1 decode) 4x DP 1.4	1 Video Encoder 2 Video Decoder (+AV1 decode)	1 Video Encoder 2 Video Decoder
RT Core	No	No	Yes	Yes	Yes
FP64	Yes	Yes	No	No	No
TDP	250W	165W	300W	150W	70W
Graphics			Best	Better	Good
DL/Compute	Ultimate	Fastest	Fastest	Faster	Fast

## Intel DP 4U 10 GPU System: SYS-420GP-TNR

4U NVIDIA 10- PCIe GPU Intel® Xeon® Scalable CPU System



### System Front View



### System Rear View

#### Subject to change without notice



- Supports Upto 10 Double Width PCIe GPUs
- Dual 3rd Gen Intel® Xeon® Scalable Processors

#### **Key Applications**

- AI Compute/Model Training/Deep Learning (HPC)
- Cloud rendering •
- Real-time high quality multi-GPU ray tracing •
- High performance simulation of complex 3D





**Specifications** 

<b>CPU –</b> Dual Socket	Memory – 32 DIMM Slots	
Dual 3rd Gen Intel® Xeon® Scalable Processors	32 DIMMs, up to 8TB Registered ECC DDR4	
Upto 270W TDP	3200MHz SDRAM	
<b>Drives –</b> 24 Hot-Swap Bays	<b>Expansion –</b> 12 PCI-E Slots	
16x HOT SWAP 2.5" SATA/SAS	12 PCIe 4.0 x16 (FHFL)	
2x M.2 NVMe	10 PCIe GPUs Double Width FHFL	
8x HOT SWAP 2.5" NVMe	AIOM support	
I/O ports 1 BMC LAN port 1 VGA port 2 USB 3.0 ports	<b>Power Supply –</b> N+N Redundant 4x 2000W High-efficiency (Titanium level) power supply	



## Intel DP 4U 4 GPU System: SYS-740GP-TNRT

4U NVIDIA 4-PCIe GPU Intel® Xeon® Scalable CPU System





Subject to change without notice

System Rear View

- Key Features
  - Supports Upto 4 Double Width GPUs
  - Dual 3rd Gen Intel® Xeon® Scalable Processors

#### Key Applications

- AI Compute/Model Training/Deep Learning (HPC
- Real-time high quality multi-GPU ray tracing
- High performance simulation of complex 3D



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	Specifications
<b>CPU –</b> Dual Socket Dual 3rd Gen Intel® Xeon® Scalable Processors Upto 270W TDP	<b>Memory –</b> 16 DIMM Slots 16 DIMMs, up to 4TB Registered ECC DDR4 3200MHz SDRAM
<b>Drives –</b> 8 Hot-swap 3.5" drive bays Up to 8 NVMe drives (4 NVMe drives supported by default) Support 2x M.2 ( SATA or NVMe).	<b>Expansion –</b> 7 PCI-E Slots 6 PCI-E Gen 4.0 x16 (4 FHFL & 2 LP) 1 PCI-E 4.0 x8 LP
I/O ports Dual 10GbE ports 1 BMC LAN port 1 VGA port • 6 USB 3.0 ports	<b>Power Supply –</b> N+N Redundant 2x 2200W High-efficiency (Titanium level) power supply





### Intel DP 1U 4 GPU System: SYS-120GQ-TNRT

1U NVIDIA 4- PCIe GPU Intel® Xeon® Scalable CPU System



System Front View



System Rear View

#### Subject to change without notice

- Key Features
  - Supports Upto 4 Double Width GPUs
  - Dual 3rd Gen Intel® Xeon® Scalable Processors

#### Key Applications

- AI Compute/Model Training/Deep Learning
- High-performance Computing (HPC)





	Specifications
<b>CPU – Dual Socket</b> Dual 3rd Gen Intel® Xeon® Scalable Processors Upto 205W TDP	Memory – 16 DIMM Slots 16 DIMMs, up to 4TB Registered ECC DDR4 3200MHz SDRAM
Drives – 4 x 2.5" drive bays 1x M.2 NVMe Supported (Internal) 2x 2.5" NVMe Hot-swap drive bays 2x 2.5" SATA Internal Fixed drive bays	Expansion – 6 PCI-E Slots 6 PCIe 4.0 x16 (4 FHFL & 2 LP)
I/O ports 1 BMC LAN port 1 VGA port 2 USB 3.0 ports	<b>Power Supply –</b> N+N Redundant 2x 2000W High-efficiency (Titanium level) power supply

11/11/2021



## Intel DP 2U 6 GPU System: SYS-220GP-TNR

2U NVIDIA 6- PCIe GPU Intel® Xeon® Scalable CPU System







#### Subject to change without notice

System Front View

#### • Key Features

- Supports Upto 6 Double Width GPUs
- Dual 3rd Gen Intel® Xeon® Scalable Processors

#### Key Applications

- AI Compute/Model Training/Deep Learning (HPC)
- Virtual Work station
- Video Conferencing
- 4K Cloud Games



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#### Specifications

<b>CPU – Dual Socket</b>	Memory – 16 DIMM Slots
Dual 3rd Gen Intel® Xeon® Scalable Processors	16 DIMMs, up to 4TB Registered ECC DDR4
Upto 270W TDP	3200MHz SDRAM
Drives – 10 x 2.5" drive bays	Expansion – 8 PCI-E Slots
Up to10x 2.5" drive bays	6 PCIe 4.0 x16 FHFL
Up to 6 NVMe drives	2 PCIe 4.0 x8 LP
2x M.2	AIOM support
I/O ports 1 BMC LAN port 1 VGA port 2 USB 3.0 ports	<b>Power Supply –</b> N+N Redundant 2x 2600W High-efficiency (Titanium level) power supply

## Intel UP 2U 2Node GPU System: SYS-210GP-DNR

2U NVIDIA 3-PCIe GPU Per Node Intel® Xeon® Scalable CPU System



### System Front View



System Rear View

#### **Key Features**

UP 3rd Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Processor Energy-efficient Resource-saving Architecture



### **Key Applications**

Perfect Platform for Video Streaming High-End Cloud Gaming

<b>CPU –</b> Single Socket (Per Node) Single 3rd Gen Intel® Xeon® Scalable Processors Upto 270W TDP	Memory – 8 DIMM Slots (Per Node) 8 DIMMs, up to 2TB Registered ECC DDR4 3200MHz SDRAM
Drives – (Per Node) 2 U.2 NMVe Gen 4.0 (Hot-swap drive bay) 2 M.2 NVMe Gen 3.0 (On-board from PCH) 2 SATA DOM for internal OS drive	Expansion – 3 PCI-E Slots (Per Node) Up to 3 Double Width FHFL AIOM support
I/O ports (Per Node) BMC LAN port 1 VGA port 2 USB 3.0 ports and 1 COM port	<b>Power Supply (Enclosure)</b> 2x 2600W High-efficiency (Titanium level) power supply



**Specifications** 



# H12 GPU System Roadmap

Highest Performance and Flexibility for AL/ML and HPC Applications

## SXM GPU Systems

# PCIe GPU Systems



### H12: 2U-4GPU AS -2124GQ-NART

Scale-able Performance, Redstone GPU



### H12: 2U- 2Node 3GPU AS -2114GT-DNR

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Flexible Architecture, PCIe GPU



### H12: 4U-8GPU AS -4124GO-NART

Integrated Performance, Delta GPU



### H12: 4U-8GPU AS -4124GS-TNR

Direct Attach & Low Latency, PCIe GPU

## HGX A100 8-GPU (Delta) Server: AS -4124GO-NART(NART+)



4U NVIDIA SXM A100 + 8-GPU AMD EPYC CPU System



System Front



System Rear

Key Features

- Supports 8 A100 40GB SXM4 GPUs
- Platform with NVIDIA<sup>®</sup> NVLINK<sup>™</sup> + NVIDIA<sup>®</sup> NVSwitch<sup>™</sup>
- Dual AMD EPYC<sup>™</sup> Series Processors

### • Key Applications

- Al Compute/Model Training/Deep Learning
- High-performance Computing (HPC)







	Specifications
CPU – Dual Socket Dual AMD EPYC™ 7002/7003 Series (Rome/Milan) Processors Up to 128 Cores, CPU TDP up to 280W	Memory – 32 DIMM Slots 32 DIMMs, up to 8TB Registered ECC DDR4 3200MHz SDRAM
Drives – 6 Hot-Swap Bays 6 NVMe U.2 (4 from PCIe Switch & 2 from CPU) 2 NVMe M.2 (Internal) (Option for up to 10 hot-swap U.2 NVMe 2.5" available)	Expansion – 10 PCI-E Slots 8 PCIe 4.0 x16 LP from PCIe switch 1 PCIe 4.0 x16 & 1 PCIe 4.0 x8 LP from CPUs AIOM support
I/O ports 1 VGA port 2 USB 3.0 ports	<b>Power Supply –</b> N+N Redundant 4x 3000W High-efficiency (Titanium level) power supply OR 4x 2200W High-efficiency (Titanium level) power supply (3+1)

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### HGX A100 4-GPU (Redstone) Server: AS -2124GQ-NART/+ 2U NVIDIA SXM A100 + 4-GPU AMD EPYC CPU System



System Front



System Rear

- Key Features
  - Supports 4 A100 40GB SXM4 GPUs
  - Direct connect PCI-E Gen 4 Platform with NVIDIA<sup>®</sup> NVLink™
  - Dual AMD EPYC<sup>™</sup> Series Processors

### Key Applications

- Al Compute/Model Training/Deep Learning
- High-performance Computing (HPC)



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		Specifications
CPU – Dual Socket Dual AMD EPYC™ 7002/7003 Series (Rome/Milan) Processors Up to 128 Cores, CPU TDP up to 280W	Memory – 32 DI 32 DIMMs, up to 81 3200MHz SDRAM	MM Slots IB Registered ECC DDR4
<b>Drives –</b> 4 Hot-Swap Bays 4x 2.5" SAS/SATA/NVMe Hybrid	Expansion – 5 F 4x PCI-E Gen 4 x10 1x PCI-E Gen 4 x8	6 LP
<b>Networking –</b> Dual 10GbE 2x RJ45 10GbE 1x RJ45 1GbE IPMI	Power Supply – 2x 2200W Titanium 2x 3000W Titanium	

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### Subject to change without notice

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### DP 4U 8 GPU Server: AS -4124GS-TNR

### 4U PCIe Gen 4 AMD EPYC CPU System

System Front

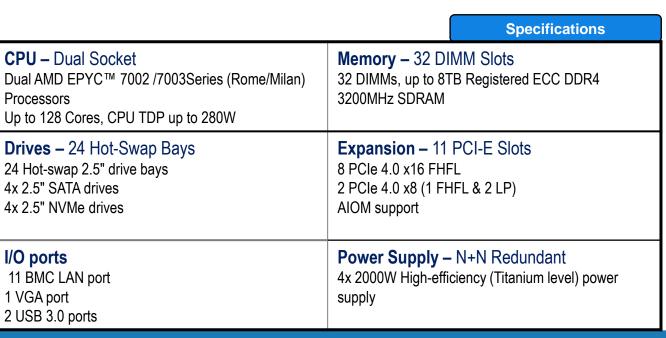
System Rear



- Supports 8 PCIe GPUs Double Width FHFL
- Dual AMD EPYC<sup>™</sup> Series Processors

### Key Applications

- AI Compute/Model Training/Deep Learning
- High-performance Computing (HPC)











# A+ UP 2U 2Node 3 GPU Server



#### Specifications **Processor Support** Ø AS -2114GT-DNR Single EPYC processor (Socket SP3), Up to 64 cores 280W TDP 2 Memory Capacity 8 DIMM, up to 2TB DDR4 3200 MHz Reg. ECC GPU Support slots per node 3 3 Double Width GPUs in PCI-E 4.0 x16 slots or 6 Single Width GPUs in PCI-E 4.0 x16 slots **Front View** Expansion slots per node 4 6 PCI-E 4.0 x16 FH slots, 1 AIOM slot / OCP3.0 Networking & I/O – per node A 1 Flexible networking via AIOM 1 RJ45 Dedicated IPMI LAN port **Rear View** 2 USB 3.0 ports 1 VGA port 6 System Management IPMI ASPEED AST2600 BMC with dedicated LAN port ...................... Drive Bays per node 7 4 Hot-swap PCI-E Gen4 x4 U.2 drives (2 default at front, 2 optional at rear) 2 PCI-E Gen4 x4 M.2 connectors **Key Features:** 8 System Cooling 4x Heavy duty 8cm PWM fans 3 Direct Attached GPUs Power Supply 9 PCIe Gen 4.0 AMD Radeon Instinct & Nvidia Enterprise GPUs 2600W 1+ 1 High-efficiency (Titanium level, 96%) supplies Flexible Architecture 10 Dimensions 4x Hot-swap 8cm counter-rotating cooling fans 17.25" (W) x 3.47" (H) x 29.9" (D)

### New Available SXM4 GPU Liquid Cooling System



Redstone System SYS-220GQ-TNAR+ AS-2124GQ-NART/+



GPU Node: 4x Nvidia SXM4 400W/500W GPU CPU Node: 2x AMD EPYC 280W CPU /Loop



Delta System SYS-420GP-TNAR/+ AS-4124GO-NART/+



GPU Node: 8x Nvidia SXM4 400W/500W GPU CPU Node: 2x AMD EPYC 280W CPU /Loop 2x Intel ICX 270W CPU /Loop



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